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Appeal No. 15-1309

## IN THE UNITED STATES COURT OF APPEALS FOR THE FEDERAL CIRCUIT

## TSMC TECHNOLOGY, INC., TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LIMITED and TSMC NORTH AMERICA CORP.,

Plaintiffs-Appellees,

VS.

ZOND, LLC,

Defendant-Appellant.

Appeal from Order Granting Defendant's Motion to Enjoin and Denying Plaintiff's Motion to Transfer entered by the United States District Court for the District of Delaware, Chief Judge Leonard P. Stark, Case No. 14-CV-00721-LPS-CJB

## STIPULATION OF VOLUNTARY DISMISSAL

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Defendant-Appellant Zond, LLC ("Zond") and Plaintiffs-Appellees TSMC Technology, Inc., Taiwan Semiconductor Manufacturing Company, Limited and TSMC North America Corp. ("TSMC"), have agreed to settle and compromise all their claims and counterclaims between each other in the above-captioned action. Therefore, Zond and TSMC hereby stipulate and agree:

- The above-captioned appeal is voluntarily dismissed pursuant to Fed. R.
   App. P. 42(b);
- 2. Each party shall bear its own costs and expenses relating to this appeal.

March 6, 2015

Respectfully submitted,

### /s/ David C. Radulescu

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I, David C. Radulescu, hereby certify that the content of this document is acceptable to all persons required to sign this document and that I obtained the authorizations necessary for the electronic signatures of all parties for this document.

/s/ David C. Radulescu
David C. Radulescu



Form 9

FORM 9. Certificate of Interest

UNITED STATES COURT OF APPEALS FOR THE FEDERAL CIRCUIT  TSMC TECHNOLOGY, INC., TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LIMITED AND TSMC NORTH AMERICA CORP. V. ZOND, LLC	
No. <u>15-1309</u>	
CERTIFICATE OF INTEREST	
Counsel for the (petitioner) (appellant) (respondent) ( appellant, Zond, LLC certifies the following ( if necessary):	appellee) (amicus) (name of party) use "None" if applicable; use extra sheets
<ol> <li>The full name of every party or amicus represented by me is:</li> <li>Zond, LLC</li> </ol>	
2. The name of the real party in interest (if the party named in the caption is not the real party in interest) represented by me is:  None.	
3. All parent corporations and any publicly held companies that own 10 percent or more of the stock of the party or amicus curiae represented by me are:  None.	
4.  The names of all law firms and the partners or associates that appeared for the party or amicus now represented by me in the trial court or agency or are expected to appear in this court are:	
Please see attached list.	
Date	Signature of counsel Pavid C. Radulescu Printed name of counsel
Please Note: All questions must be answered cc:	



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